

Data Sheet N2679, REV.-

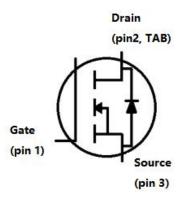
S2M0160120D



S2M0160120D 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0160120D is single SiC Power MOSFET packaged in TO-247AD case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0160120D is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 175mQ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Characteristics Symbol Condition Max. Units 1200 V Drain Source Voltage VDSS V_{GS} = 0V, I_{DS} = 100uA, T_{C} = 25°C Gate Source Voltage V_{GSS} Tc = 25 ° C, Absolute maximum values, AC -10 to +25 V (f>1Hz) Gate Source Voltage VGSOP T_c = 25°C Recommended Operational Values -5 to +20 V **Continuous Drain Current** $V_{GS} = 20V, T_C = 25^{\circ}C$ I_D 17 А I_D $V_{GS} = 20V, T_{C} = 100^{\circ}C$ 12 А Tc=25°C 40 Pulsed Drain Current А ID,pulse T_c=25°C W Power Dissipation P_{D} 130

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Maximum Ratings(T=25°C unless otherwise specified)



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Electrical Characteristics (T=25 $^{\circ}$ C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit s	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 100 uA	1200			V	
	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 2.5 \text{ mA}$	2.0	2.8	4	V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 2.5 mA, T _J = 175 °C		1.9		V	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 1200 V, V _{GS} = 0 V		1	100	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20 V, V _{DS} = 0 V			250	nA	
Drain Source On-State	Dest	V _{GS} = 20 V, I _D = 10 A		175	196	mΩ	
Resistance	R _{DS(on)}	V_{GS} = 20 V, I _D = 10 A, T _J = 175 °C		300		mΩ	
Tananakutana		V _{DS} = 20 V, I _D = 10 A		3.3		S	
Transconductance	gfs	V _{DS} = 20 V, I _D = 10 A, T _J = 175 °C	°C 3.4		S		
Input Capacitance	C _{ISS}	V _{GS} = 0 V,		513			
Output Capacitance	Coss	$V_{DS} = 1000 V$		35.6		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25 mV f = 100 kHz		2.59			
Coss Stored Energy	Eoss			20.5		uJ	
Turn-On Switching Energy	E _{ON}	V_{DS} = 800 V, V_{GS} = -5/+20 V		90.3		-	
Turn-Off Switching Energy	E _{OFF}	ID =10 A, RG(ext)=2.5 Ω		54.5		uJ	
Turn-On Delay Time	$t_{d(on)}$			3.5			
Rise Time	tr	V _{DS} = 800 V. V _{GS} = -5/20 V		11.8			
Turn-Off Delay Time	$t_{d(off)}$	$V_{DS} = 800 \text{ V}, V_{GS} = -5/20 \text{ V}$ $I_D = 10 \text{ A}, R_{G(ext)} = 2.5 \Omega, R_L = 80 \Omega$		7.0		ns	
Fall Time	t _f			13.4			
Internal Gate Resistance	R _{G(int)}	f = 1 MHz, VAC = 25 mV, D-S short		6.5		Ω	
Gate to Source Charge	Q _{gs}	V _{DS} = 800 V, V _{GS} = -5/20 V 7		7.7			
Gate to Drain Charge	Q_{gd}	I _D = 10 A		8.2		nC	
Total Gate Charge	Qg			26.5			



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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 5 A	3.3		V
	V _{SD}	V _{GS} = -5 V, I _{SD} = 5 A, T _J = 175 °C	2.9		V
Continuous Diode Forward Current	ls	V _{GS} = -5 ∨, T _C = 25 ℃	20		А
Reverse Recovery Time	t _{rr}	V _{GS} = -5 V, I _{SD} = 10 A, T _J = 25 °C	6.6		ns
Reverse Recovery Charge	Qrr	V _R = 800 V	0.04		uC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 2533 A/µs	11		А

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	1.15	°C/W
Maximum Thermal Resistance Junction to Ambient	R _{0JA}		56	°C/W

Ordering Information:

Device	Package	Shipping
S2M0160120D	TO-247AD	30pcs/tube

Marking Diagram



Where XXXXX is YYWWL

S2M = Device Type

0160 = $R_{DS}(on)$ 120 = Reverse Voltage

= Reverse Voltage (1200V) = Package

- D = Pac SSG = SSG
- YY = Year

L

WW = Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

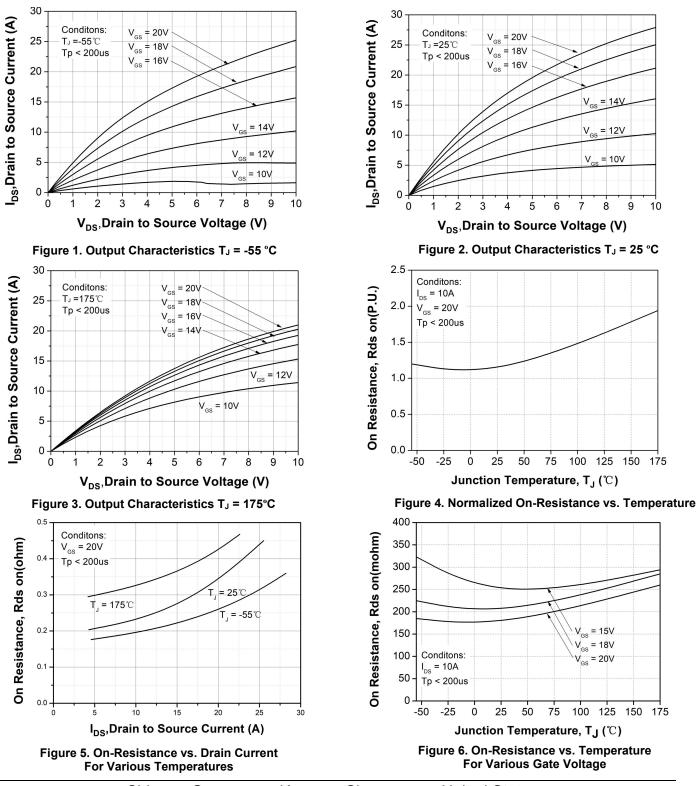
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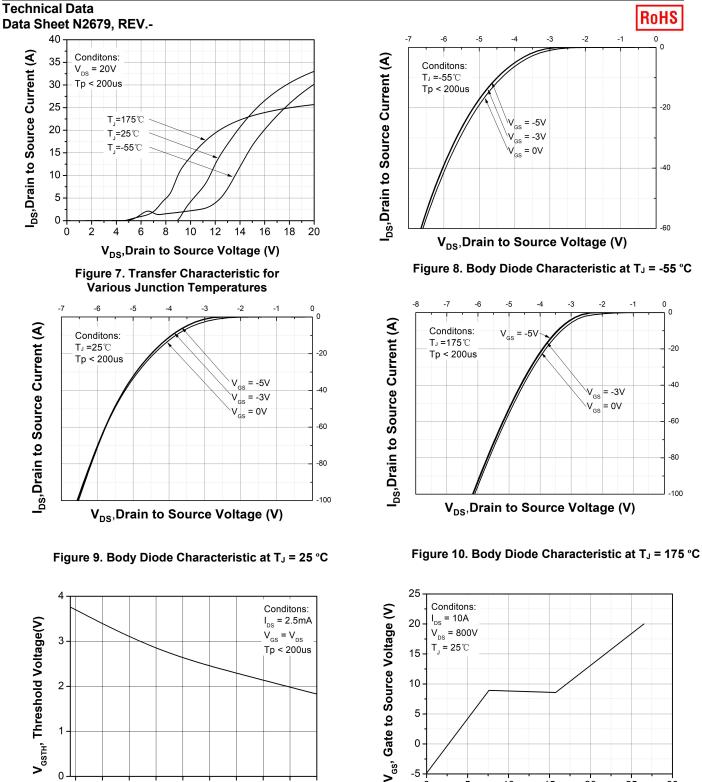
Ratings and Characteristics Curves



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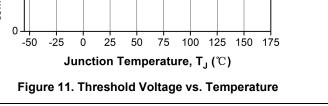


Figure 12. Gate Charge Characteristic

20

15

Q_c, Gate Charge (nC)

25

30

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0

-5

0

5

10



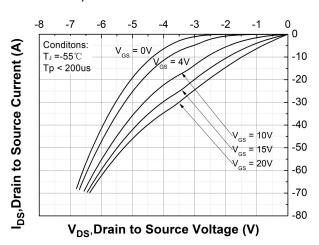
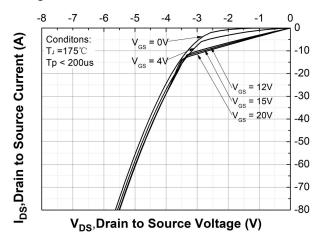
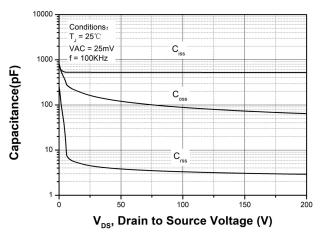
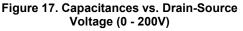


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C









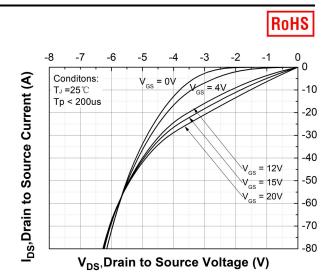


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

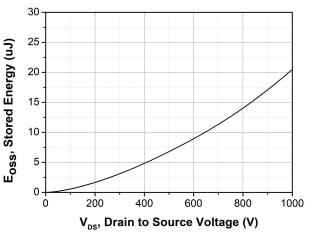


Figure 16. Output Capacitor Stored Energy

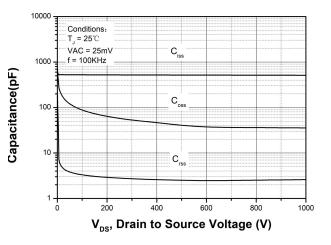
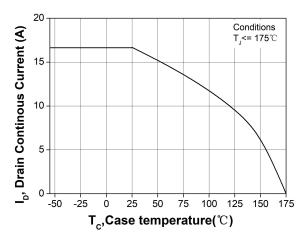


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

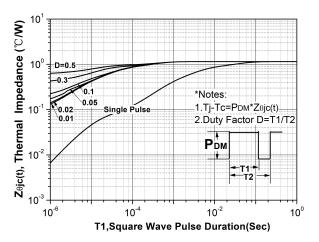
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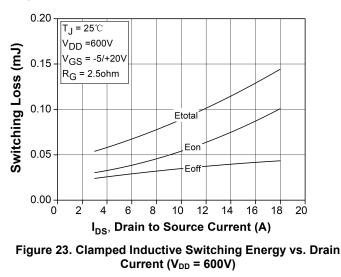
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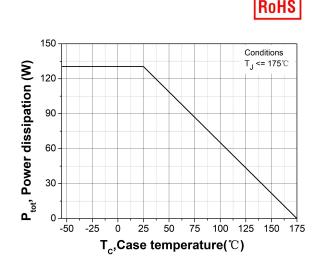
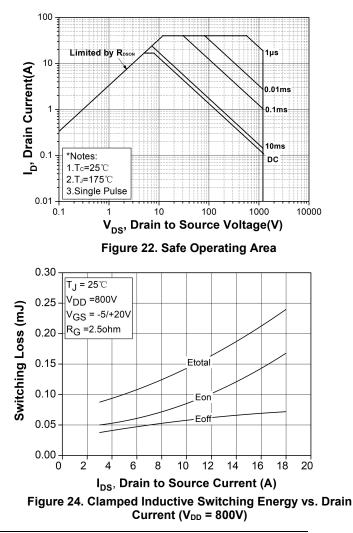
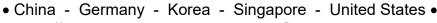


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature





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Τ.

= 25°C

= 800V

V_{GS} = -5/+20V

= 10A

0.30

0.25

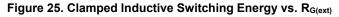
0.20

0.15

Switching Loss (mJ) 0.10 0.05 0.00 5 10 15 20 25 0

Eto

R_G, Gate Resistance (ohm)



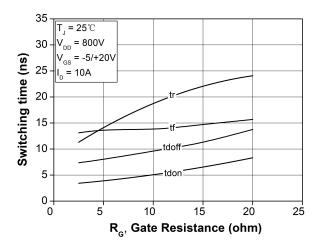
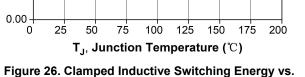


Figure 27. Switching Times vs. R_{G(ext)}



0.30

0.25

0.20

0.15

0.10

0.05

Switching Loss (mJ)

R_G

V_{GS}

= 10A

= 2.5ohm

= 800V

= -5/+20V

Figure 26. Clamped Inductive Switching Energy vs. Temperature

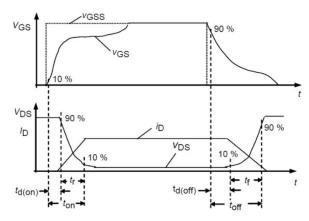


Figure 28. Switching Times Definition





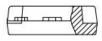
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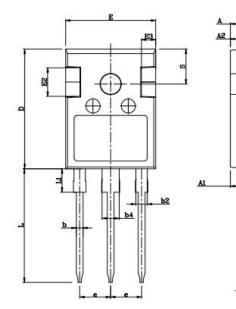


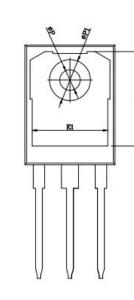
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Mechanical Dimensions TO-247AD







C

COMMON DIMENSIONS

SYMBOL -	mm			
	Min	Nom	Max	
А	4.80	5.00	5.20	
Al	2.23	2.41	2.59	
A2	1.85	2.00	2.15	
b	1.11	1.21	1.36	
b2	1.91	2.01	2.21	
b4	2.91	3.01	3.21	
с	0.51	0.61	0.75	
D	20.80	21.00	21.30	
DI	16.25	16.55	16.85	
Е	15.50	15.80	16.10	
El	13.00	13.26	13.56	
E2	<mark>4.8</mark> 0	5.00	5.20	
E3	2,30	2.50	2.70	
e	5.44BSC			
L	19.82	19.92	20.22	
L1	3.94	4,12	4.30	
ØP	3.40	3.60	3.80	
ØP1	7.08	7.19	7.30	
S	6.15BSC			

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